

# International **IR** Rectifier

PD - 96263

## IRF8714GPbF

HEXFET® Power MOSFET

<b>V<sub>DSS</sub></b>	<b>R<sub>DS(on)</sub> max</b>	<b>Q<sub>g</sub></b>
<b>30V</b>	<b>8.7mΩ@V<sub>GS</sub> = 10V</b>	<b>8.1nC</b>

### Applications

- Control MOSFET of Sync-Buck Converters used for Notebook Processor Power
- Control MOSFET for Isolated DC-DC Converters in Networking Systems

### Benefits

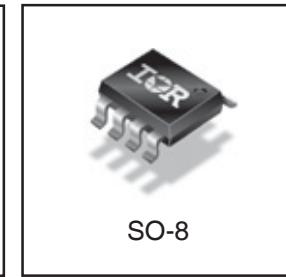
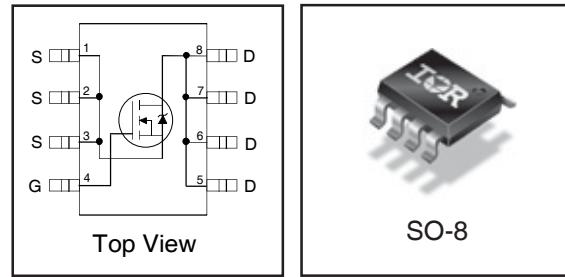
- Very Low Gate Charge
- Very Low R<sub>DS(on)</sub> at 4.5V V<sub>GS</sub>
- Ultra-Low Gate Impedance
- Fully Characterized Avalanche Voltage and Current
- 20V V<sub>GS</sub> Max. Gate Rating
- 100% tested for R<sub>g</sub>
- Lead-Free
- Halogen-Free

### Description

The IRF8714GPbF incorporates the latest HEXFET Power MOSFET Silicon Technology into the industry standard SO-8 package. The IRF8714GPbF has been optimized for parameters that are critical in synchronous buck operation including R<sub>ds(on)</sub> and gate charge to reduce both conduction and switching losses. The reduced total losses make this product ideal for high efficiency DC-DC converters that power the latest generation of processors for Notebook and Netcom applications.

### Absolute Maximum Ratings

	Parameter	Max.	Units
V <sub>DS</sub>	Drain-to-Source Voltage	30	V
V <sub>GS</sub>	Gate-to-Source Voltage	± 20	
I <sub>D</sub> @ T <sub>A</sub> = 25°C	Continuous Drain Current, V <sub>GS</sub> @ 10V	14	A
I <sub>D</sub> @ T <sub>A</sub> = 70°C	Continuous Drain Current, V <sub>GS</sub> @ 10V	11	
I <sub>DM</sub>	Pulsed Drain Current ①	110	W
P <sub>D</sub> @ T <sub>A</sub> = 25°C	Power Dissipation	2.5	
P <sub>D</sub> @ T <sub>A</sub> = 70°C	Power Dissipation	1.6	W/°C
	Linear Derating Factor	0.02	
T <sub>J</sub>	Operating Junction and	-55 to + 150	°C
T <sub>STG</sub>	Storage Temperature Range		



### Thermal Resistance

	Parameter	Typ.	Max.	Units
R <sub>0JL</sub>	Junction-to-Drain Lead ⑤	—	20	°C/W
R <sub>0JA</sub>	Junction-to-Ambient ④	—	50	

Notes ① through ⑤ are on page 9

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**Static @  $T_J = 25^\circ\text{C}$  (unless otherwise specified)**

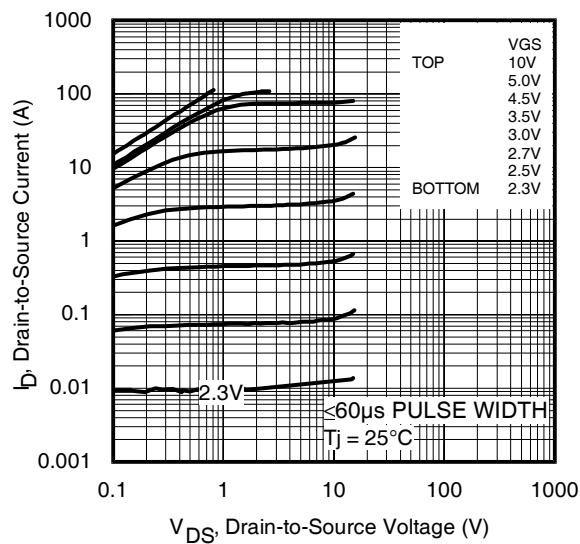
	Parameter	Min.	Typ.	Max.	Units	Conditions
$\text{BV}_{\text{DSS}}$	Drain-to-Source Breakdown Voltage	30	—	—	V	$V_{\text{GS}} = 0\text{V}$ , $I_D = 250\mu\text{A}$
$\Delta \text{BV}_{\text{DSS}}/\Delta T_J$	Breakdown Voltage Temp. Coefficient	—	0.021	—	V/ $^\circ\text{C}$	Reference to $25^\circ\text{C}$ , $I_D = 1\text{mA}$
$R_{\text{DS(on)}}$	Static Drain-to-Source On-Resistance	—	7.1	8.7	m $\Omega$	$V_{\text{GS}} = 10\text{V}$ , $I_D = 14\text{A}$ ③
		—	10.9	13		$V_{\text{GS}} = 4.5\text{V}$ , $I_D = 11\text{A}$ ③
$V_{\text{GS(th)}}$	Gate Threshold Voltage	1.35	1.80	2.35	V	$V_{\text{DS}} = V_{\text{GS}}$ , $I_D = 25\mu\text{A}$
$\Delta V_{\text{GS(th)}}$	Gate Threshold Voltage Coefficient	—	-6.0	—	mV/ $^\circ\text{C}$	$V_{\text{DS}} = V_{\text{GS}}$ , $I_D = 25\mu\text{A}$
$I_{\text{DSS}}$	Drain-to-Source Leakage Current	—	—	1.0	$\mu\text{A}$	$V_{\text{DS}} = 24\text{V}$ , $V_{\text{GS}} = 0\text{V}$
		—	—	150		$V_{\text{DS}} = 24\text{V}$ , $V_{\text{GS}} = 0\text{V}$ , $T_J = 125^\circ\text{C}$
$I_{\text{GSS}}$	Gate-to-Source Forward Leakage	—	—	100	nA	$V_{\text{GS}} = 20\text{V}$
	Gate-to-Source Reverse Leakage	—	—	-100		$V_{\text{GS}} = -20\text{V}$
$g_{\text{fs}}$	Forward Transconductance	71	—	—	S	$V_{\text{DS}} = 15\text{V}$ , $I_D = 11\text{A}$
$Q_g$	Total Gate Charge	—	8.1	12	nC	$V_{\text{DS}} = 15\text{V}$ $V_{\text{GS}} = 4.5\text{V}$ $I_D = 11\text{A}$ See Figs. 15 & 16
$Q_{\text{gs}1}$	Pre-V <sub>th</sub> Gate-to-Source Charge	—	1.9	—		
$Q_{\text{gs}2}$	Post-V <sub>th</sub> Gate-to-Source Charge	—	1.0	—		
$Q_{\text{gd}}$	Gate-to-Drain Charge	—	3.0	—		
$Q_{\text{godr}}$	Gate Charge Overdrive	—	2.2	—		
$Q_{\text{sw}}$	Switch Charge ( $Q_{\text{gs}2} + Q_{\text{gd}}$ )	—	4.0	—	pF	$V_{\text{DS}} = 16\text{V}$ , $V_{\text{GS}} = 0\text{V}$ $V_{\text{DD}} = 15\text{V}$ , $V_{\text{GS}} = 4.5\text{V}$ $I_D = 11\text{A}$ $R_G = 1.8\Omega$ See Fig. 18
$Q_{\text{oss}}$	Output Charge	—	4.8	—		
$R_g$	Gate Resistance	—	1.6	2.6		
$t_{\text{d(on)}}$	Turn-On Delay Time	—	10	—		
$t_r$	Rise Time	—	9.9	—		
$t_{\text{d(off)}}$	Turn-Off Delay Time	—	11	—	ns	$t_f$ $V_{\text{DD}} = 15\text{V}$ , $V_{\text{GS}} = 4.5\text{V}$ $I_D = 11\text{A}$ $R_G = 1.8\Omega$ See Fig. 18
$t_f$	Fall Time	—	5.0	—		
$C_{\text{iss}}$	Input Capacitance	—	1020	—		
$C_{\text{oss}}$	Output Capacitance	—	220	—	pF	$V_{\text{GS}} = 0\text{V}$ $V_{\text{DS}} = 15\text{V}$ $f = 1.0\text{MHz}$
$C_{\text{rss}}$	Reverse Transfer Capacitance	—	110	—		

## Avalanche Characteristics

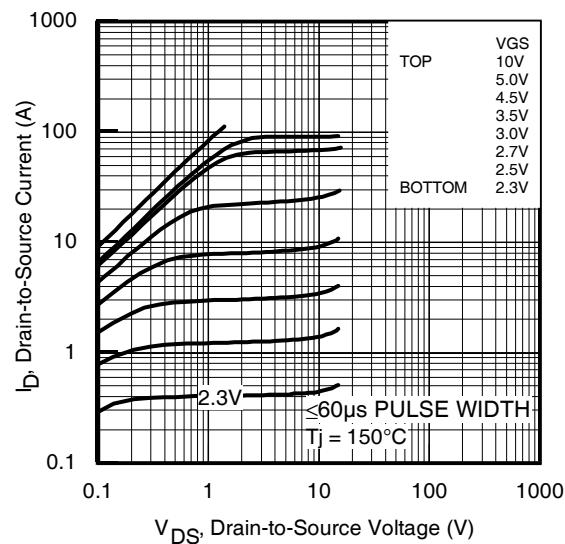
	Parameter	Typ.	Max.	Units
$E_{\text{AS}}$	Single Pulse Avalanche Energy ②	—	65	mJ
$I_{\text{AR}}$	Avalanche Current ①	—	11	A

## Diode Characteristics

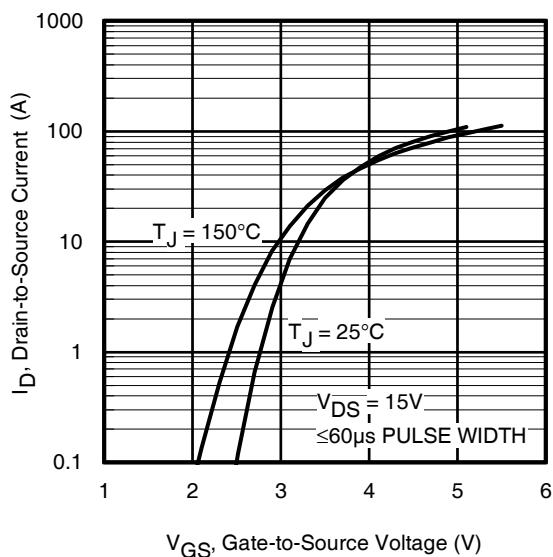
	Parameter	Min.	Typ.	Max.	Units	Conditions
$I_S$	Continuous Source Current (Body Diode)	—	—	3.1	A	MOSFET symbol showing the integral reverse p-n junction diode.
$I_{\text{SM}}$	Pulsed Source Current (Body Diode) ①	—	—	110		
$V_{\text{SD}}$	Diode Forward Voltage	—	—	1.0	V	$T_J = 25^\circ\text{C}$ , $I_S = 11\text{A}$ , $V_{\text{GS}} = 0\text{V}$ ③
$t_{\text{rr}}$	Reverse Recovery Time	—	14	21	ns	$T_J = 25^\circ\text{C}$ , $I_F = 11\text{A}$ , $V_{\text{DD}} = 15\text{V}$
$Q_{\text{rr}}$	Reverse Recovery Charge	—	15	23	nC	$dI/dt = 300\text{A}/\mu\text{s}$ ③
$t_{\text{on}}$	Forward Turn-On Time	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				



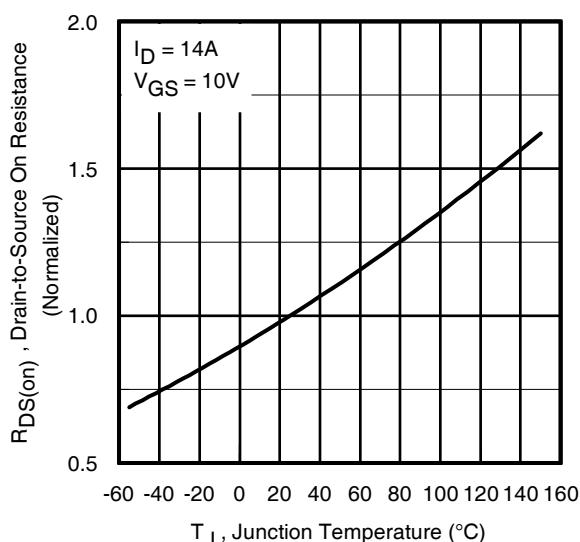
**Fig 1.** Typical Output Characteristics



**Fig 2.** Typical Output Characteristics



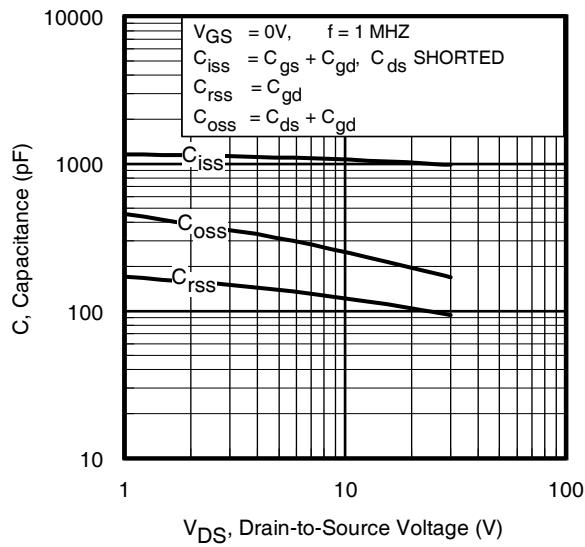
**Fig 3.** Typical Transfer Characteristics



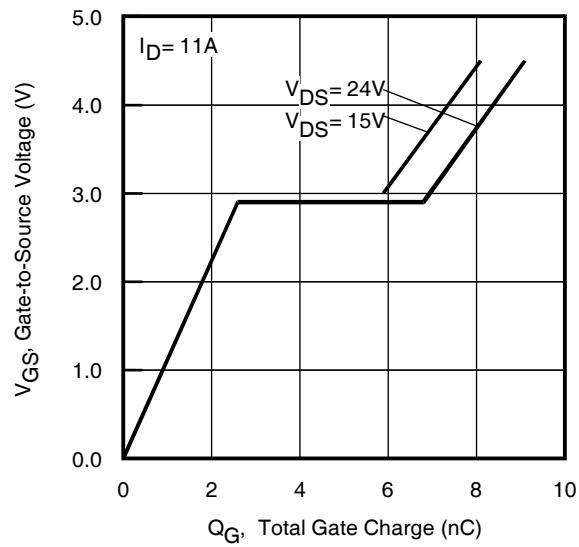
**Fig 4.** Normalized On-Resistance  
vs. Temperature

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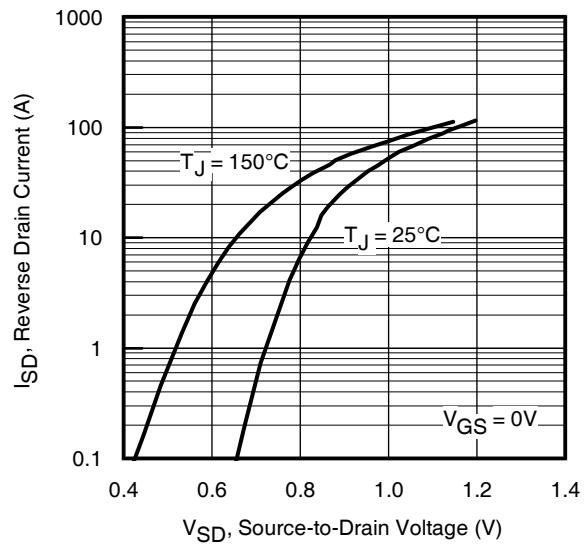
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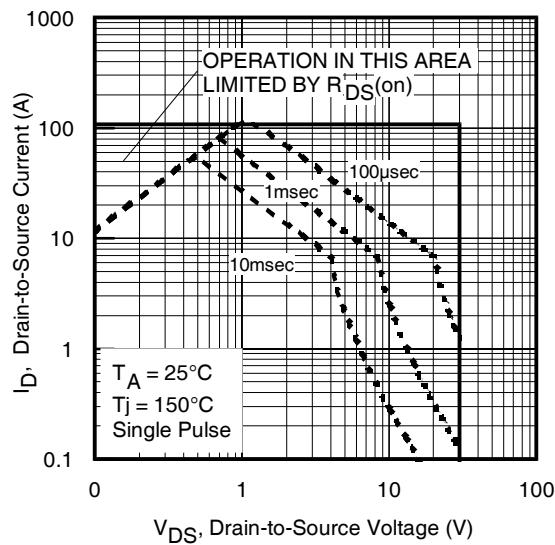
**Fig 5.** Typical Capacitance vs.  
Drain-to-Source Voltage



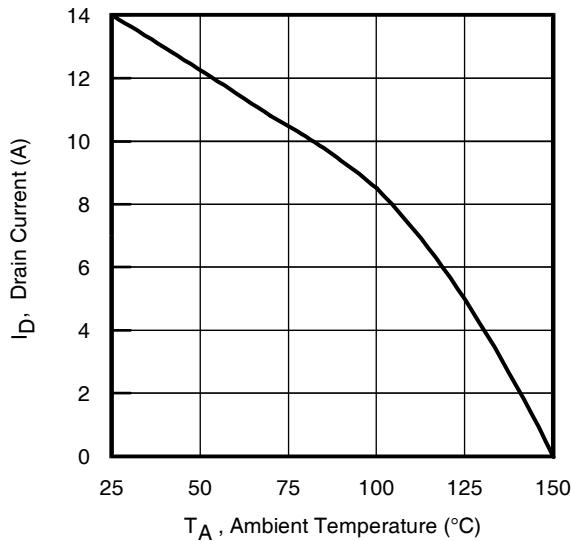
**Fig 6.** Typical Gate Charge Vs.  
Gate-to-Source Voltage



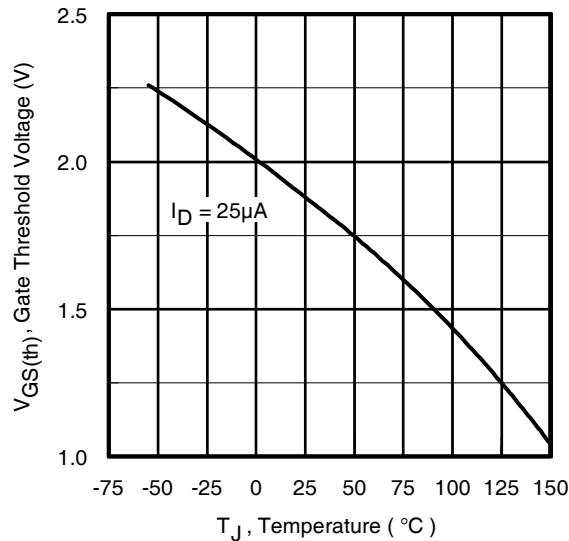
**Fig 7.** Typical Source-Drain Diode  
Forward Voltage



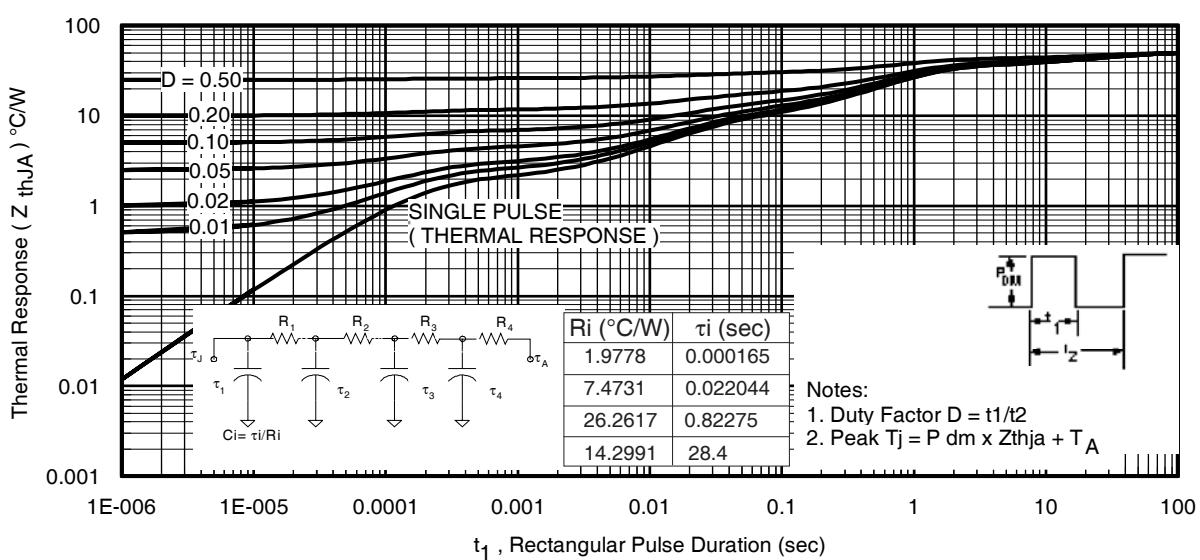
**Fig 8.** Maximum Safe Operating Area



**Fig 9.** Maximum Drain Current vs.  
Ambient Temperature



**Fig 10.** Threshold Voltage vs. Temperature



**Fig 11.** Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

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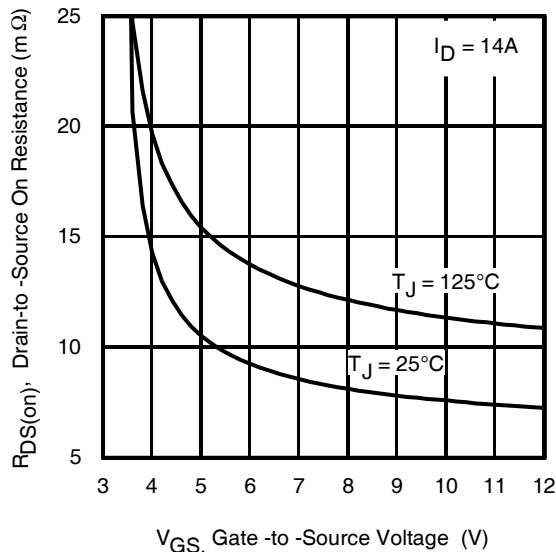


Fig 12. On-Resistance vs. Gate Voltage

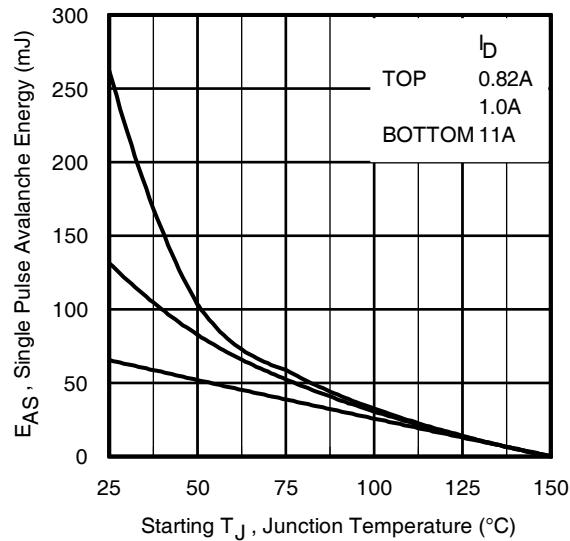


Fig 13. Maximum Avalanche Energy vs. Drain Current

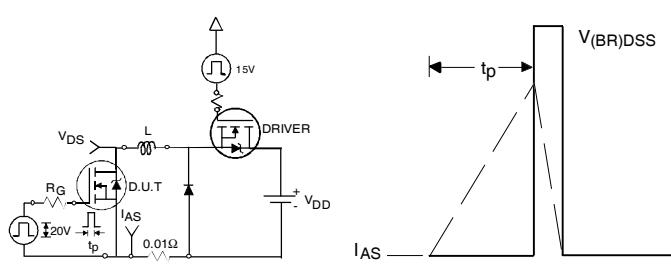


Fig 14. Unclamped Inductive Test Circuit and Waveform

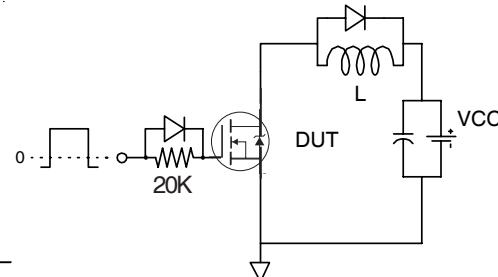


Fig 15. Gate Charge Test Circuit

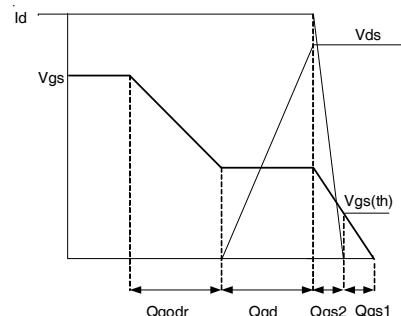
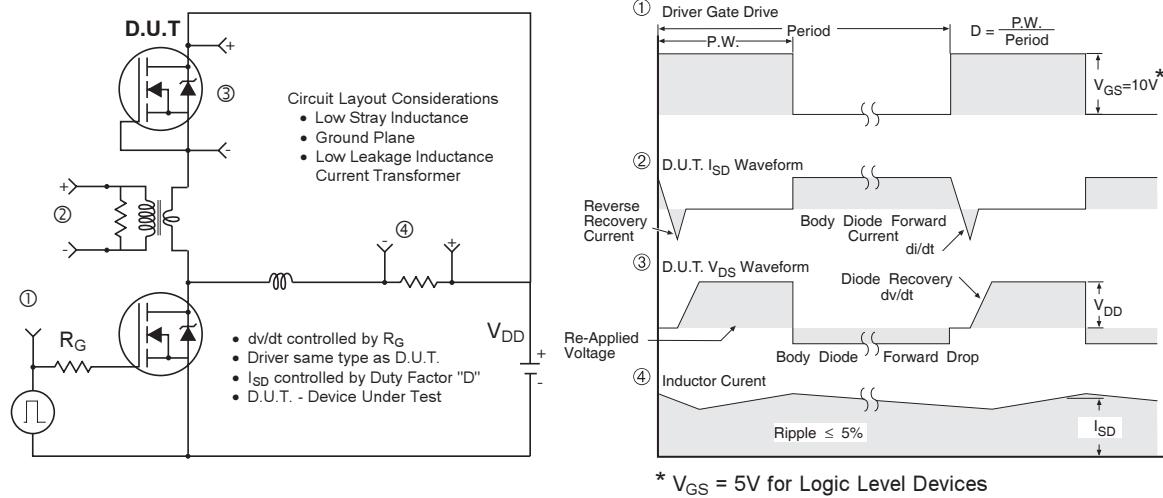
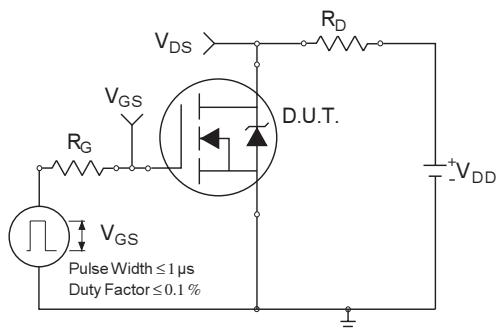


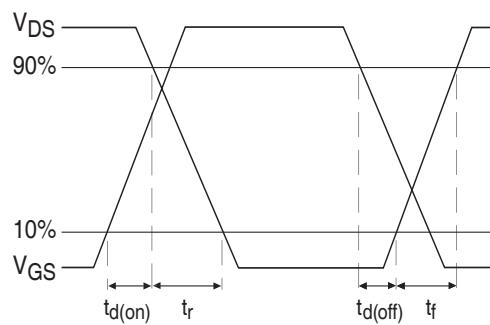
Fig 16. Gate Charge Waveform



**Fig 17.** Peak Diode Recovery  $dv/dt$  Test Circuit for N-Channel HEXFET® Power MOSFETs



**Fig 18a.** Switching Time Test Circuit



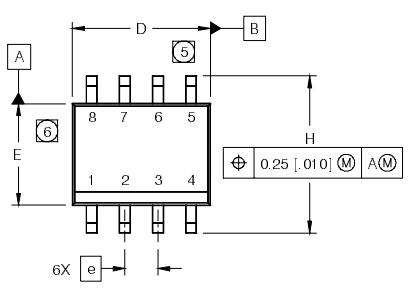
**Fig 18b.** Switching Time Waveforms

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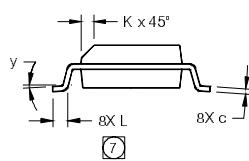
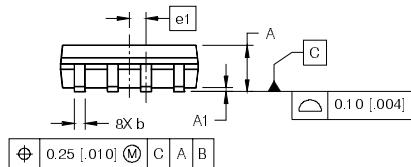
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## SO-8 Package Outline(Mosfet & Fetky)

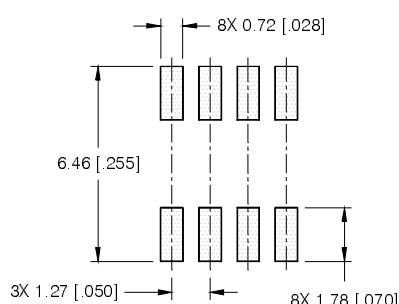
Dimensions are shown in millimeters (inches)



DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.0532	.0688	1.35	1.75
A1	.0040	.0098	0.10	0.25
b	.013	.020	0.33	0.51
c	.0075	.0098	0.19	0.25
D	.189	.1968	4.80	5.00
E	.1497	.1574	3.80	4.00
e	.050	BASIC	1.27	BASIC
e1	.025	BASIC	0.635	BASIC
H	.2284	.2440	5.80	6.20
K	.0099	.0196	0.25	0.50
L	.016	.050	0.40	1.27
y	0°	8°	0°	8°

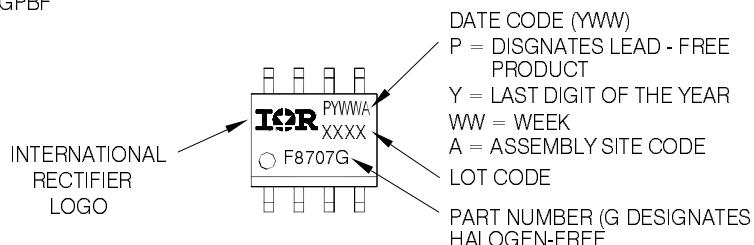


FOOTPRINT



## SO-8 Part Marking Information

EXAMPLE: THIS IS AN IRF8707GPBF

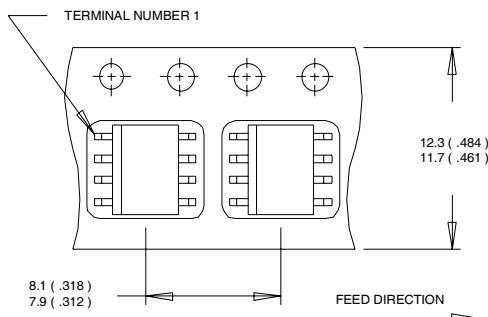


Note: For the most current drawing please refer to IR website at <http://www.irf.com/package/>

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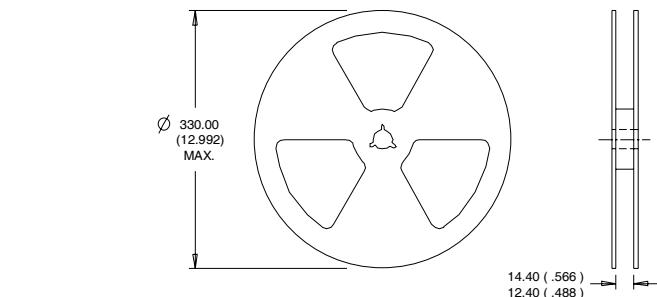
## SO-8 Tape and Reel

Dimensions are shown in millimeters (inches)



NOTES:

1. CONTROLLING DIMENSION : MILLIMETER.
2. ALL DIMENSIONS ARE SHOWN IN MILLIMETERS (INCHES).
3. OUTLINE CONFORMS TO EIA-481 & EIA-541.



NOTES :

1. CONTROLLING DIMENSION : MILLIMETER.
2. OUTLINE CONFORMS TO EIA-481 & EIA-541.

**Notes:**

- ① Repetitive rating; pulse width limited by max. junction temperature.
- ② Starting  $T_J = 25^\circ\text{C}$ ,  $L = 1.1\text{mH}$ ,  $R_G = 25\Omega$ ,  $I_{AS} = 11\text{A}$ .
- ③ Pulse width  $\leq 400\mu\text{s}$ ; duty cycle  $\leq 2\%$ .
- ④ When mounted on 1 inch square copper board.
- ⑤  $R_\theta$  is measured at  $T_J$  of approximately  $90^\circ\text{C}$ .

Note: For the most current drawing please refer to IR website at <http://www.irf.com/package>

Data and specifications subject to change without notice.  
This product has been designed and qualified for the Consumer market.  
Qualification Standards can be found on IR's Web site.

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**IR WORLD HEADQUARTERS:** 233 Kansas St., El Segundo, California 90245, USA Tel: (310) 252-7105  
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